# Current-Shunt Monitor, Voltage Output, Bi-Directional Zero-Drift

The NCS210, NCS211, NCS212, NCS213, NCS214, and NCS215 are voltage output current shunt monitors that can measure voltage across shunts at common–mode voltages from -0.3 V to 26 V, independent of supply voltage. Six fixed gains are available: 50 V/V, 75 V/V, 100 V/V, 200 V/V, 500 V/V, or 1000 V/V. The low offset of the zero–drift architecture enables current sensing with maximum drops across the shunt as low as 10 mV full–scale.

The devices can operate from a single +2.7 V to +26 V power supply, drawing a maximum of  $100~\mu\text{A}$  of supply current. All versions are specified over the extended operating temperature range ( $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ).

#### **Features**

- Wide Common–Mode Input Range –0.3 V to 26 V
- Supply Voltage Range from 2.7 V to 26 V
- Low Offset Voltage  $\pm 60 \mu V$  Max
- Low Offset Drift (0.1 μV/°C)
- Low Gain Error (max 1%)
- Rail-to-rail Input and Output Capability
- Low Current Consumption (typ 65 μA, 100 μA max)
- NCV Prefix for Automotive and Other Applications Requiring Unique Site Qualified and PPAP Capable
- These are Pb-free Devices

## **Typical Applications**

- Current Sensing (High-Side/Low-Side)
- Automotive
- Telecom
- Sensors



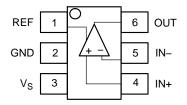
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SC70-6 SQ SUFFIX CASE 419B

#### PIN CONNECTIONS



#### **MARKING DIAGRAM**



XXX = Specific Device Code (See page 4)

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

Product	Gain	R3-R4	R1-R2
NCS213	50	20 kΩ	1 ΜΩ
NCS215	75	13.3 kΩ	1 ΜΩ
NCS214	100	10 kΩ	1 ΜΩ
NCS210	200	5 kΩ	1 ΜΩ
NCS211	500	2 kΩ	1 ΜΩ
NCS212	1000	1 kΩ	1 ΜΩ

$$V_{OUT} = (I_{LOAD} \times R_{SHUNT})GAIN + V_{REF}$$

### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information on page 4 of this data sheet.

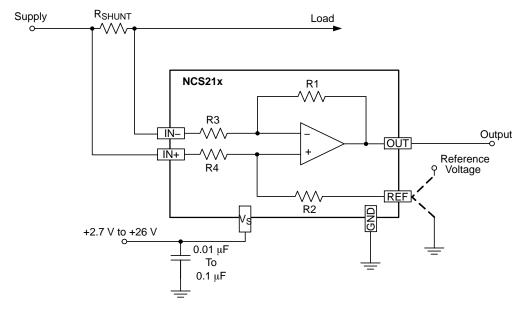


Figure 1. Application Schematic

Table 1. MAXIMUM RATINGS

Rating		Symbol	Value	Unit	
Supply Voltage (Note 1)		V <sub>S</sub>	+26	V	
Analog Inputs	Differential (V <sub>IN+</sub> )–(V <sub>IN-</sub> )	$V_{IN+,}V_{IN-}$	-26 to +26	V	
	Common-Mode (Note 2)		GND-0.3 to +26		
REF Input	•	$V_{REF}$	GND-0.3 to (V <sub>s</sub> ) +0.3	V	
Output (Note 2)		V <sub>OUT</sub>	GND-0.3 to (V <sub>s</sub> ) +0.3	V	
Input Current into Any Pin (	Note 2)		5	mA	
Maximum Junction Tempera	ature	T <sub>J(max)</sub>	+150	°C	
Storage Temperature Range	е	TSTG	-65 to +150	°C	
ESD Capability, Human Boo	dy Model (Note 3)	HBM	±3000	V	
ESD Capability, Machine M	odel (Note 3)	MM	±100	V	
Charged Device Model (No	te 3)	CDM	±1000	V	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- Refer to ELECTRICAL CHĂRACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for safe operating parameters.
- 2. Input voltage at any pin may exceed the voltage shown if current at that pin is limited to 5 mA.
- 3. This device series incorporates ESD protection and is tested by the following methods
  - ESD Human Body Model tested per AEC-Q100-002 (EIA/JÉSD22-A114)
  - ESD Machine Model tested per AEC-Q100-003 (EIA/JESD22-A115)
  - ESD Charged Device Model tested per AEC-Q100-011.
  - Latchup Current Maximum Rating: 50 mA per JEDEC standard: JESD78

#### **Table 2. THERMAL CHARACTERISTICS**

Rating	Symbol	Value	Unit
Thermal Characteristics, SC70 (Note 4) Thermal Resistance, Junction–to–Air (Note 5)	$R_{\theta JA}$	250	°C/W

- Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for safe
  operating parameters.
- Values based on copper area of 645 mm<sup>2</sup> (or 1 in<sup>2</sup>) of 1 oz copper thickness and FR4 PCB substrate.

#### **Table 3. RECOMMENDED OPERATING RANGES**

Rating	Symbol	Min	Max	Unit
Supply Voltage	V <sub>S</sub>	2.7	26	V
Ambient Temperature		-40	125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

### **Table 4. ELECTRICAL CHARACTERISTICS**

 $\textbf{Boldface} \text{ limits apply over the specified temperature range, } T_A = -40^{\circ}\text{C to } 125^{\circ}\text{C}, \text{ guaranteed by characterization and/or design.}$ 

At  $T_A = +25^{\circ}$ C,  $V_{SENSE} = V_{IN+} - V_{IN-}$ NCS210, NCS213, NCS214 and NCS215:  $V_S = +5$  V,  $V_{IN+} = 12$  V, and  $V_{REF} = V_S/2$ , unless otherwise noted. NCS211 and NCS212:  $V_S = +12$  V,  $V_{IN+} = 12$  V, and  $V_{REF} = V_S/2$ , unless otherwise noted.

Parameter		Test Conditions	Symbol	Min	Тур	Max	Unit
GAIN							
NCS210 NCS211 NCS212 NCS213 NCS214 NCS215			G		200 500 1000 50 100 75		V/V
Gain Error		$V_{SENSE} = -5 \text{ mV to } 5 \text{ mV}$	G <sub>e</sub>		±0.2	±1	%
Gain Error vs. Ten	nperature	$T_A = -10^{\circ}\text{C to } 125^{\circ}\text{C}$		7	14	ppm/°C	
Nonlinearity Error		$V_{SENSE} = -5 \text{ mV to } 5 \text{ mV}$			±0.01		%
Maximum Capacit	ive Load	No sustained oscillation			1		nF
VOLTAGE OFFSE	T						
Offset Voltage (RTI Note 6) NCS210,NCS211, NCS212, NCS214, NCS215 NCS213		V <sub>SENSE</sub> = 0 mV	V <sub>OS</sub>		±0.55	±60	μV
					±5	±100	μV
Offset Drift			δV/δΤ		0.1	0.6	μV/°C
INPUT							
Input Bias Current	İ	V <sub>SENSE</sub> = 0 mV	I <sub>IB</sub>			60	μΑ
Common-Mode Ir	nput Voltage Range		$V_{CM}$	-0.3		26	V
Common–Mode Rejection Ratio	NCS210, NCS211, NCS212, NCS214, NCS215	V <sub>S</sub> = 5 V, V <sub>IN+</sub> = 2 V to +26 V, V <sub>SENSE</sub> = 0 mV	CMRR	103	115		dB
		V <sub>S</sub> = 3.3 V, V <sub>IN+</sub> = 3 V to +26 V, V <sub>SENSE</sub> = 0 mV		103	115		dB
		$V_S = 3.3 \text{ V}, V_{IN+} = 0 \text{ V to +26 V}, \\ V_{SENSE} = 0 \text{ mV } (T_A = -10^{\circ}\text{C to }85^{\circ}\text{C})$		103	120		dB
Common–Mode Rejection Ratio	NCS213	$V_S = 5 \text{ V}, V_{IN+} = 2 \text{ V to } +26 \text{ V}, \\ V_{SENSE} = 0 \text{ mV}$	CMRR	97	110		dB
		V <sub>S</sub> = 3.3 V, V <sub>IN+</sub> = 3 V to +26 V, V <sub>SENSE</sub> = 0 mV		97	110		dB
		$V_S = 3.3 \text{ V}, V_{IN+} = 0 \text{ V to } +26 \text{ V}, \\ V_{SENSE} = 0 \text{ mV } (T_A = -10^{\circ}\text{C to } 85^{\circ}\text{C})$		97	115		dB
OUTPUT							
Output Voltage Low		Referenced from GND $R_L = 10 \text{ k}\Omega$ to Ground	V <sub>OL</sub>		5	50	mV
Output Voltage High		Referenced from $V_S$ R <sub>L</sub> = 10 kΩ to Ground	V <sub>OH</sub>		0.05	0.2	V

### **Table 4. ELECTRICAL CHARACTERISTICS**

**Boldface** limits apply over the specified temperature range,  $T_A = -40^{\circ}\text{C}$  to 125°C, guaranteed by characterization and/or design.

At  $T_A = +25^{\circ}C$ ,  $V_{SENSE} = V_{IN+} - V_{IN-}$ , NCS210, NCS213, NCS214 and NCS215:  $V_S = +5$  V,  $V_{IN+} = 12$  V, and  $V_{REF} = V_S/2$ , unless otherwise noted. NCS211 and NCS212:  $V_S = +12$  V,  $V_{IN+} = 12$  V, and  $V_{REF} = V_S/2$ , unless otherwise noted.

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
DYNAMIC PERFORMANCE						
Bandwidth (f <sub>-3dB</sub> )	C <sub>LOAD</sub> = 10 pF, NCS210	BW		40		kHz
	C <sub>LOAD</sub> = 10 pF, NCS211			25		
	$C_{LOAD} = 10 pF, NCS212$			10		
	$C_{LOAD} = 10 pF, NCS213$			100		
	$C_{LOAD} = 10 pF, NCS214$			60		
	$C_{LOAD} = 10 pF, NCS215$			50		
Slew Rate		SR		0.4		V/μs
NOISE						
Spectral Density, 1 kHz (RTI Note 6)		e <sub>n</sub>		35		nV/√Hz
POWER SUPPLY						
Operating Voltage Range	V <sub>SENSE</sub> = 0 mV	Vs	2.7		26	V
Quiescent Current	V <sub>SENSE</sub> = 0 mV	$I_{DD}$		65	100	μΑ
Quiescent Current over Temperature	V <sub>SENSE</sub> = 0 mV				115	μΑ
Power Supply Rejection Ratio	$V_S$ = +2.7 V to +26 V, $V_{IN+}$ =18 V, $V_{SENSE}$ = 0 mV	PSRR		±0.1	±10	μV/V

<sup>6.</sup> RTI = referenced-to-input.

#### ORDERING INFORMATION

Device	Gain	Marking	Package	Shipping <sup>†</sup>
NCS210SQT2G	200	AAP	SC70-6	3000 / Tape and Reel
NCS211SQT2G (In Development)**	500	AAM	SC70-6	3000 / Tape and Reel
NCS212SQT2G (In Development)**	1000	AAN	SC70-6	3000 / Tape and Reel
NCS213SQT2G (In Development)**	50	AAQ	SC70-6	3000 / Tape and Reel
NCS214SQT2G (In Development)**	100	AAR	SC70-6	3000 / Tape and Reel
NCS215SQT2G (In Development)**	75	AAS	SC70-6	3000 / Tape and Reel
NCV210SQT2G * (In Development)**	200	AAP	SC70-6	3000 / Tape and Reel
NCV211SQT2G * (In Development)**	500	AAM	SC70-6	3000 / Tape and Reel
NCV212SQT2G * (In Development)**	1000	AAN	SC70-6	3000 / Tape and Reel
NCV213SQT2G * (In Development)**	50	AAQ	SC70-6	3000 / Tape and Reel
NCV214SQT2G * (In Development)**	100	AAR	SC70-6	3000 / Tape and Reel
NCV215SQT2G * (In Development)**	75	AAS	SC70-6	3000 / Tape and Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D

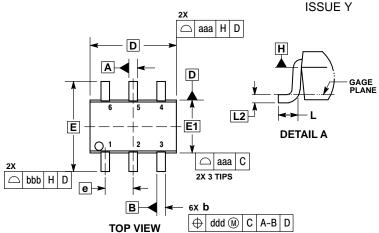
<sup>\*</sup>NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

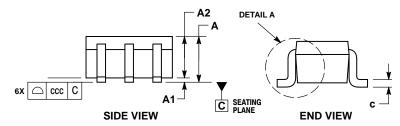
\*\* Contact local sales office for availability.

#### PACKAGE DIMENSIONS

#### SC-88/SC70-6/SOT-363

CASE 419B-02



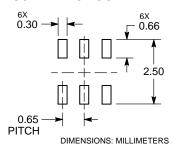


#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END.
   DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF.
- THE PLASTIC BODY AND DATUM H.
  5. DATUMS A AND B ARE DETERMINED AT DATUM H.
- DIMENSIONS 6 AND 6 APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.
- 7. DIMENSION 6 DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION 6 AT MAXIMUM MATERIAL CONDI-TION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

	MIL	LIMETE	ERS		INCHES	3
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α			1.10			0.043
A1	0.00		0.10	0.000		0.004
A2	0.70	0.90	1.00	0.027	0.035	0.039
b	0.15	0.20	0.25	0.006	0.008	0.010
С	0.08	0.15	0.22	0.003	0.006	0.009
D	1.80	2.00	2.20	0.070	0.078	0.086
E	2.00	2.10	2.20	0.078	0.082	0.086
E1	1.15	1.25	1.35	0.045	0.049	0.053
е		0.65 BSC			.026 BS	С
L	0.26	0.36	0.46	0.010	0.014	0.018
L2		0.15 BS	C	(	0.006 BS	SC
aaa		0.15			0.006	
bbb		0.30			0.012	
CCC		0.10			0.004	
ddd		0.10			0.004	

# RECOMMENDED SOLDERING FOOTPRINT



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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